



HC2302

20V N-Channel MOSFET

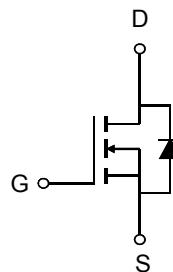
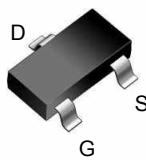
General Description

The HC2302 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is suitable for use as a load switch or in PWM applications.

Features

V_{DS}	20V
I_D (at $V_{GS}=4.5V$)	3.0A
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	45mΩ(Typ)

SOT23



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 12	V
Drain Current-Continuous	I_D (TC=25°C)	3.0	A
	I_D (TC=100°C)	1.8	A
Drain Current – Pulsed	I_{DM}	-12	A
Maximum Power Dissipation	P_D	0.8	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	°C
Thermal Characteristics			
Parameter	Symbol	Typ	Max
Thermal Resistance junction-case	$R_{\theta JC}$		80
Thermal Resistance unction-to-Ambient	$R_{\theta JA}$		125

Electrical Characteristics (TJ=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	20			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=20V, V_{GS}=0V$			1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 12V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.7	1.0	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=4.5V, I_D=3.0A$		45	55	$m\Omega$
		$V_{GS}=2.5V, I_D=2.0A$		60	80	$m\Omega$
g_{fs}	Forward Transconductance	$V_{DS}=5V, I_D=3A$		8		S
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{DS}=10V, V_{GS}=0V, F=1.0MHz$		300		pF
C_{oss}	Output Capacitance			120		pF
C_{rss}	Reverse Transfer Capacitance			80		pF
SWITCHING PARAMETERS						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=4.5V$ $V_{DS}=10V$ $R_G=6\Omega$ $I_D=3A$		15		nS
t_r	Turn-on Rise Time			85		nS
$t_{d(off)}$	Turn-Off Delay Time			45		nS
t_f	Turn-Off Fall Time			20		nS
Q_g	Total Gate Charge	$V_{DS}=10V, I_D=3A,$ $V_{GS}=4.5V$		4.0		nC
Q_{gs}	Gate-Source Charge			0.65		nC
Q_{gd}	Gate-Drain Charge			1.6		nC
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=1A$		0.70	1.3	V

Note:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

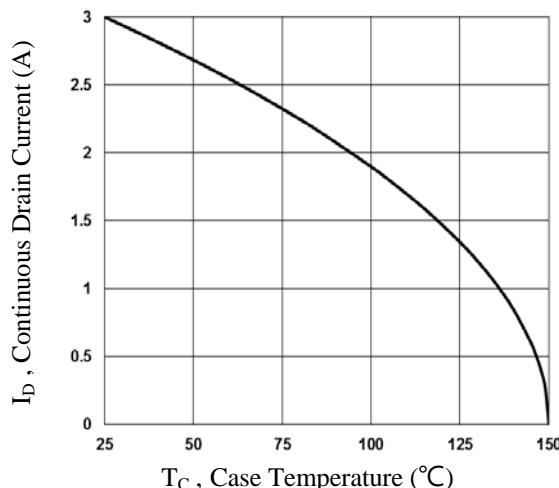


Fig.1 Continuous Drain Current vs. T_C

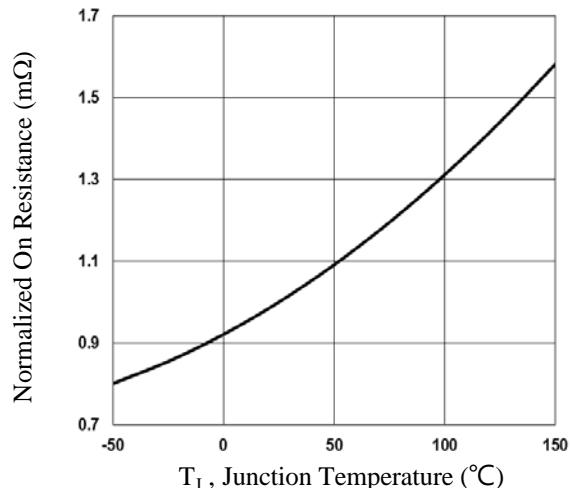


Fig.2 Normalized RDS(on) vs. T_J

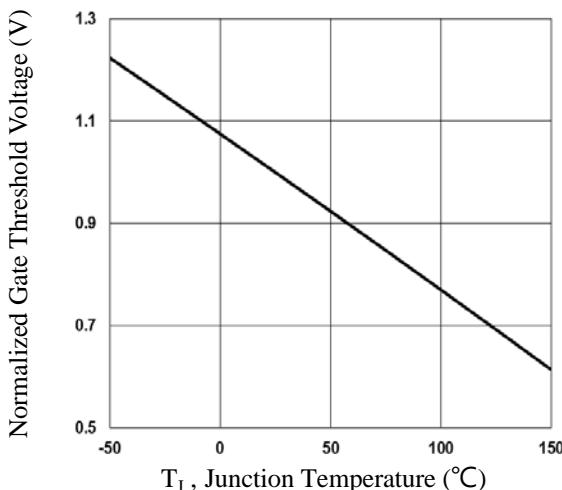


Fig.3 Normalized V_{th} vs. T_J

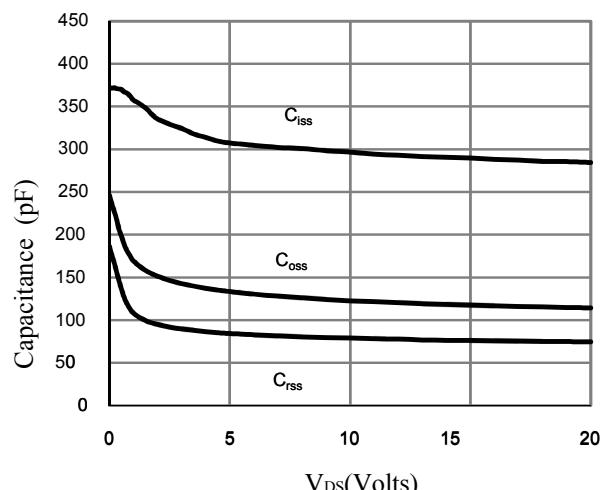


Fig.4 Capacitance Characteristics

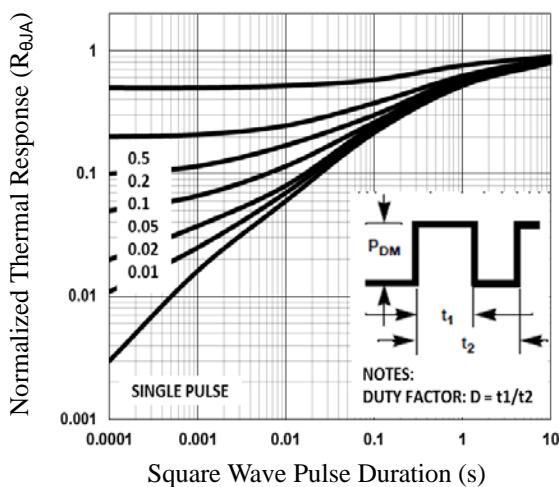


Fig.5 Normalized Transient Impedance

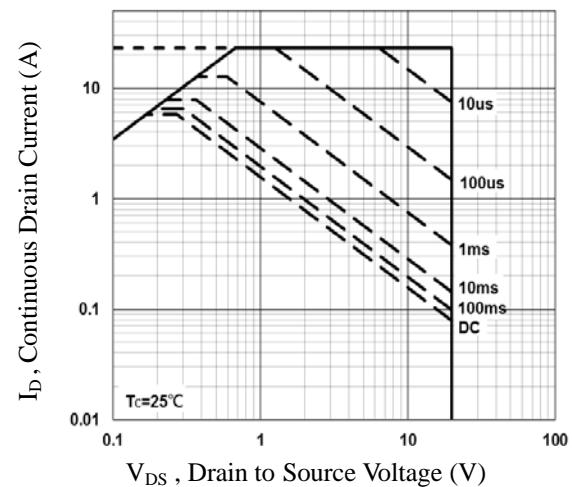
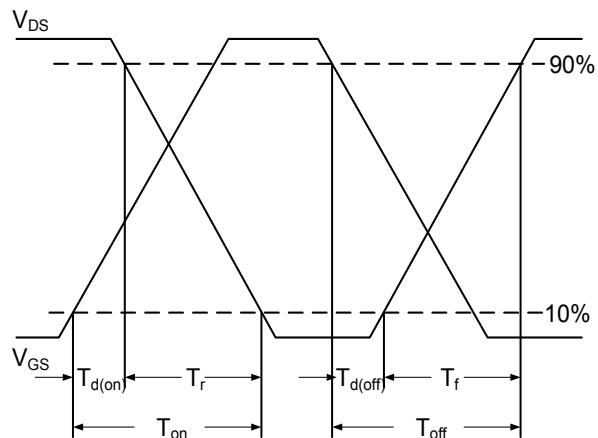
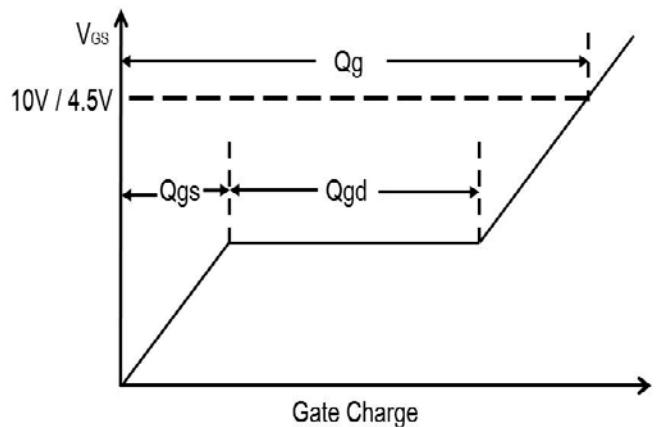
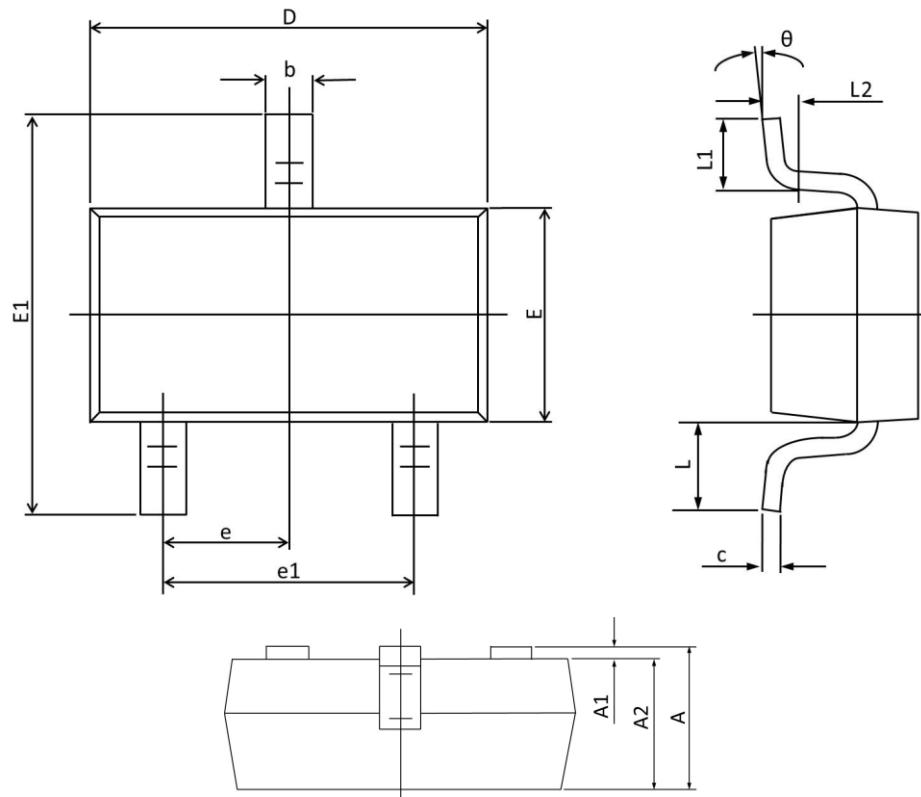


Fig.6 Maximum Safe Operation Area

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**Fig.7 Switching Time Waveform****Fig.8 Gate Charge Waveform**

SOT23 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Max	Min	Max	Min
A	1.150	0.900	0.045	0.035
A1	0.100	0.000	0.004	0.000
A2	1.050	0.900	0.041	0.035
b	0.500	0.300	0.020	0.012
c	0.150	0.080	0.006	0.003
D	3.000	2.800	0.118	0.110
E	1.400	1.200	0.055	0.047
E1	2.550	2.250	0.100	0.089
e	0.95 TYP.		0.037 TYP.	
e1	2.000	1.800	0.079	0.071
L	0.55 REF.		0.022 REF.	
L1	0.500	0.300	0.020	0.012
L2	0.25 TYP.		0.01 TYP.	
θ	8°	0°	8°	0°